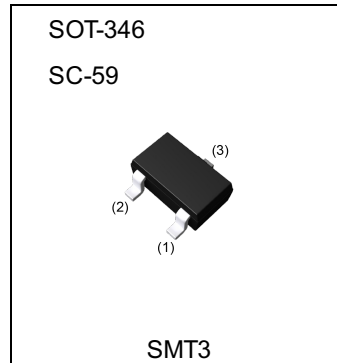


Parameter	Value
V_{CES}	32V
I_C	0.3A
R	4k Ω

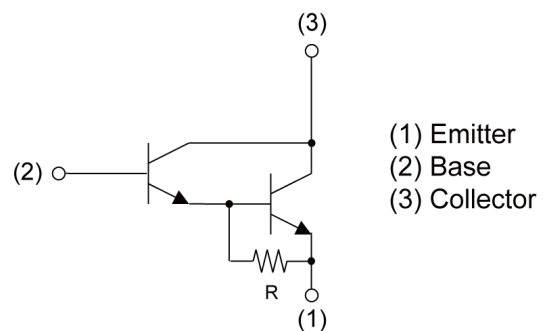
●Outline



●Features

- 1)Darlington connection for high DC current gain.
- 2)Built-in 4k Ω resistor between base and emitter.
- 3)Complements the 2SB852K.

●Inner circuit



●Application

HIGH GAIN AMPLIFIER

●Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
2SD1383K	SOT-346 (SMT3)	2928	T146	180	8	3000	W

● **Absolute maximum ratings** ($T_a = 25^\circ\text{C}$)

Parameter	Symbol	Values	Unit
Collector-base voltage	V_{CBO}	40	V
Collector-emitter voltage	V_{CES}	32	V
Emitter-base voltage	V_{EBO}	6	V
Collector current	I_{C}	0.3	A
	I_{CP}^{*1}	1.5	A
Power dissipation	P_{D}^{*2}	200	mW
Junction temperature	T_{j}	150	$^\circ\text{C}$
Range of storage temperature	T_{stg}	-55 to +150	$^\circ\text{C}$

● **Electrical characteristics** ($T_a = 25^\circ\text{C}$)

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Collector-base breakdown voltage	BV_{CBO}	$I_{\text{C}} = 100\mu\text{A}$	40	-	-	V
Collector-emitter breakdown voltage	BV_{CES}	$I_{\text{C}} = 1\text{mA}, R_{\text{BE}} = 0\Omega$	32	-	-	V
Emitter-base breakdown voltage	BV_{EBO}	$I_{\text{E}} = 100\mu\text{A}$	6	-	-	V
Collector cut-off current	I_{CBO}	$V_{\text{CB}} = 24\text{V}$	-	-	1.0	μA
Emitter cut-off current	I_{EBO}	$V_{\text{EB}} = 4.5\text{V}$	-	-	1.0	μA
Collector-emitter saturation voltage	$V_{\text{CE(sat)}}^{*3}$	$I_{\text{C}} = 200\text{mA}, I_{\text{B}} = 0.4\text{mA}$	-	-	1.5	V
DC current gain	h_{FE}^{*3}	$V_{\text{CE}} = 5\text{V}, I_{\text{C}} = 100\text{mA}$	1k	-	-	-
Transition frequency	f_{T}^{*4}	$V_{\text{CE}} = 5\text{V}, I_{\text{E}} = -10\text{mA}, f = 100\text{MHz}$	-	250	-	MHz
Output capacitance	C_{ob}	$V_{\text{CB}} = 10\text{V}, I_{\text{E}} = 0\text{A}, f = 1\text{MHz}$	-	3.0	-	pF

h_{FE} values are classified as follows :

rank	A	B	-	-	-
h_{FE}	1k-	5k-	-	-	-

*1 $P_{\text{w}}=10\text{ms}$, duty=1/15

*2 Each terminal mounted on a reference land

*3 Pulsed

*4 Characteristics of built-in transistor

● Electrical characteristic curves ($T_a = 25^\circ\text{C}$)

Fig.1 Ground emitter propagation characteristics

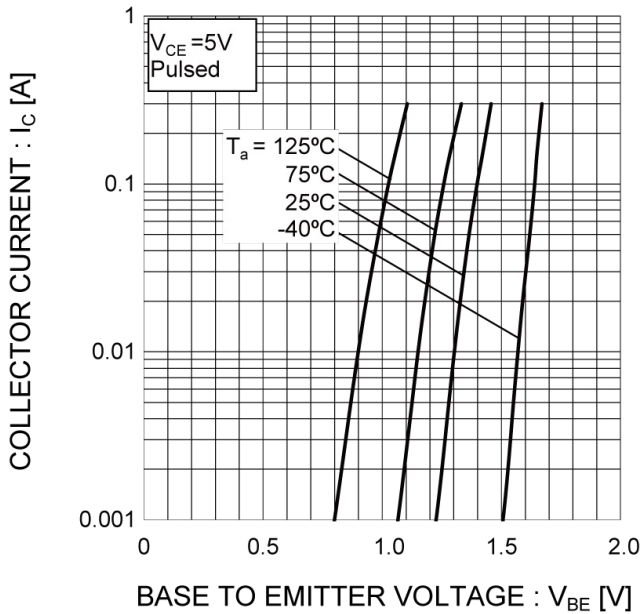


Fig.2 Grounded emitter output characteristics

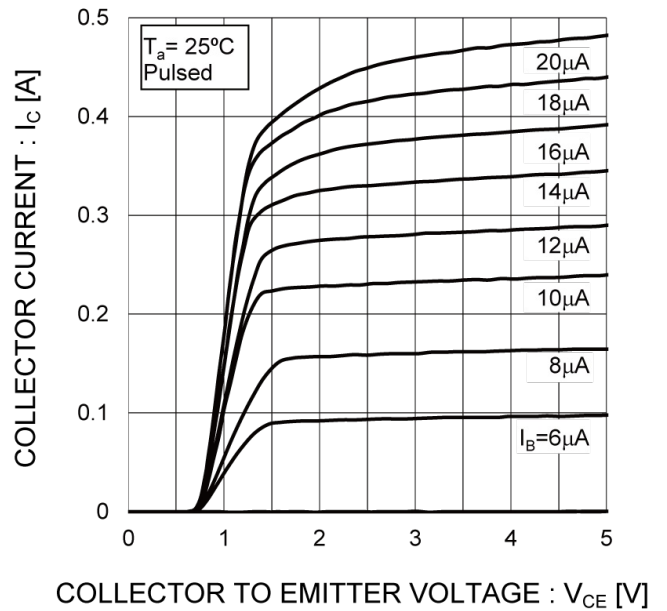


Fig.3 DC current gain vs. collector current (I)

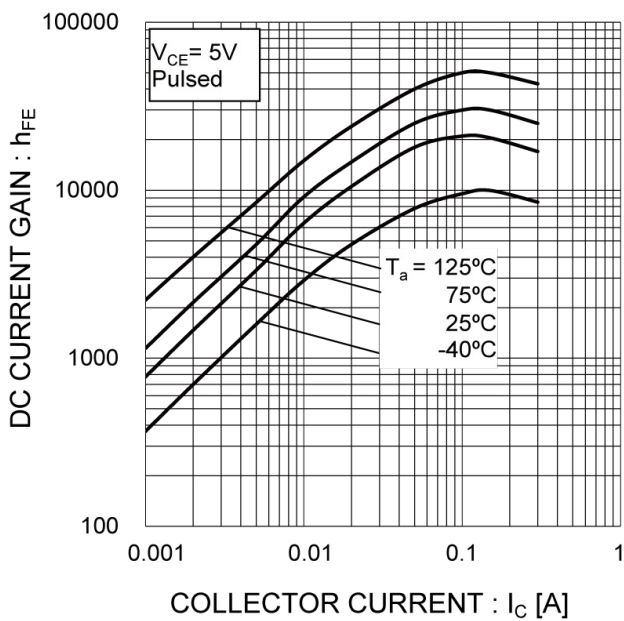
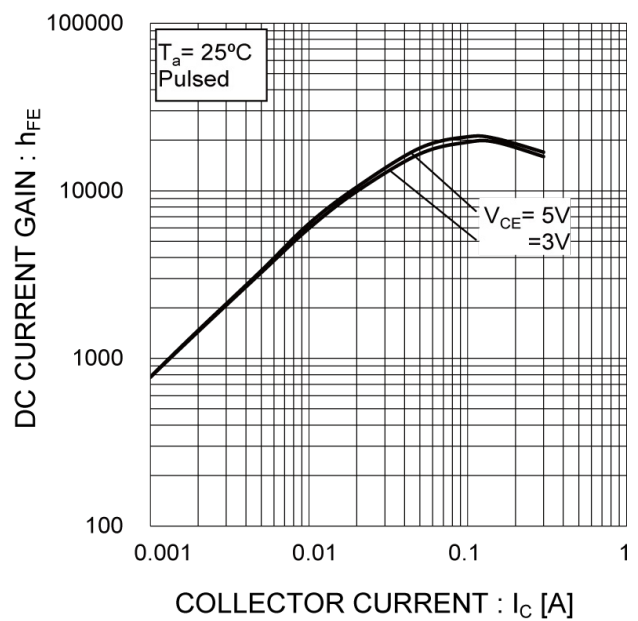


Fig.4 DC current gain vs. collector current (II)



● Electrical characteristic curves ($T_a = 25^\circ\text{C}$)

Fig.5 Collector-emitter saturation voltage vs. collector current (I)

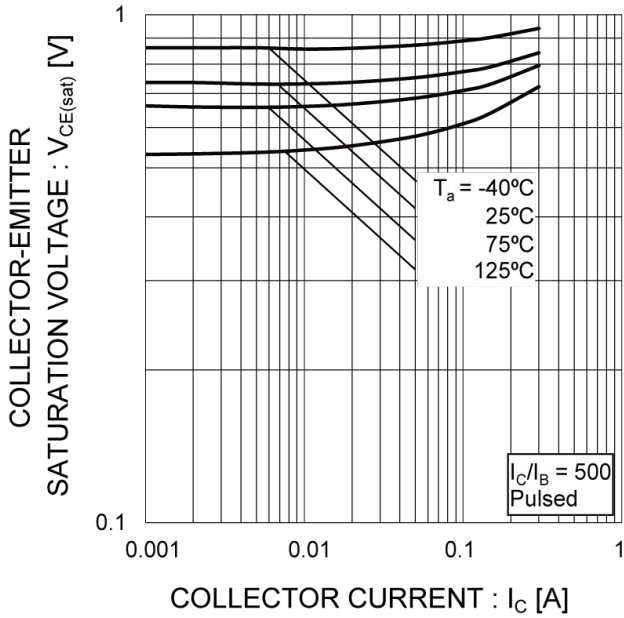


Fig.6 Collector-emitter saturation voltage vs. collector current (II)

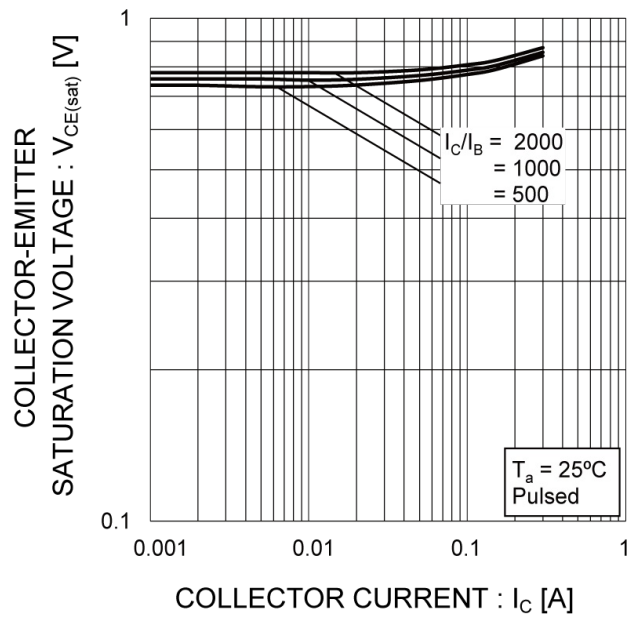
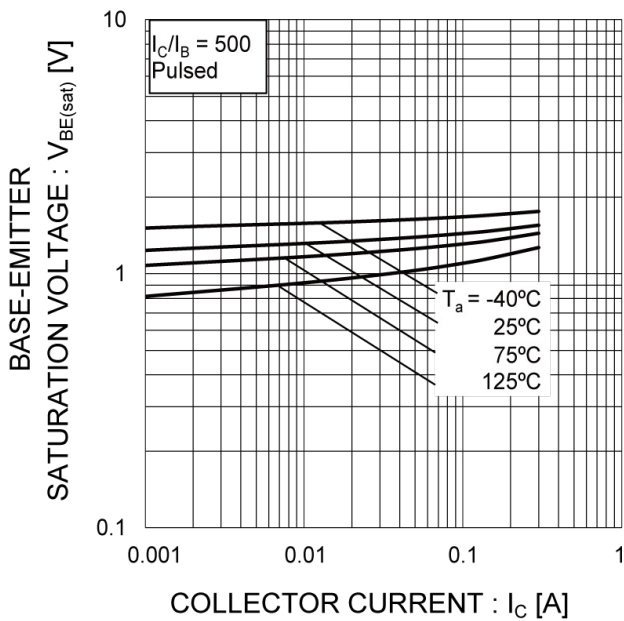


Fig.7 Base-emitter saturation voltage vs. collector current (I)



●Electrical characteristic curves($T_a = 25^\circ\text{C}$)

Fig.8 Collector output capacitance vs. collector-base voltage

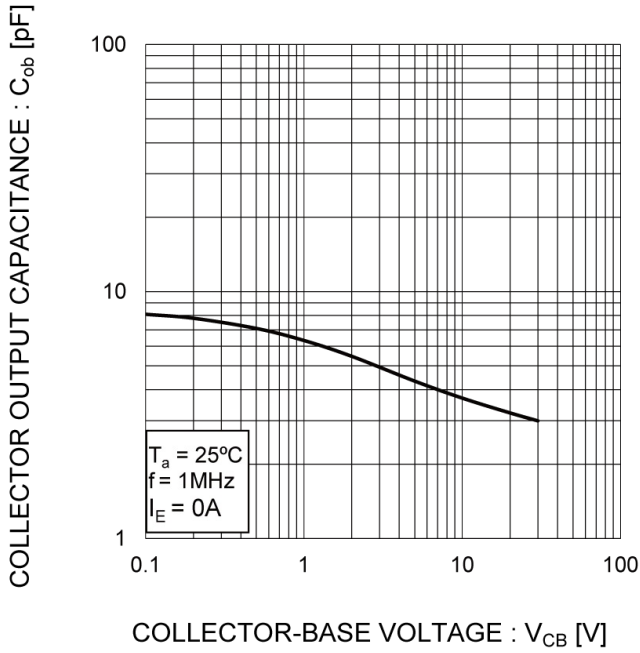


Fig.9 Emitter input capacitance vs. emitter-base voltage

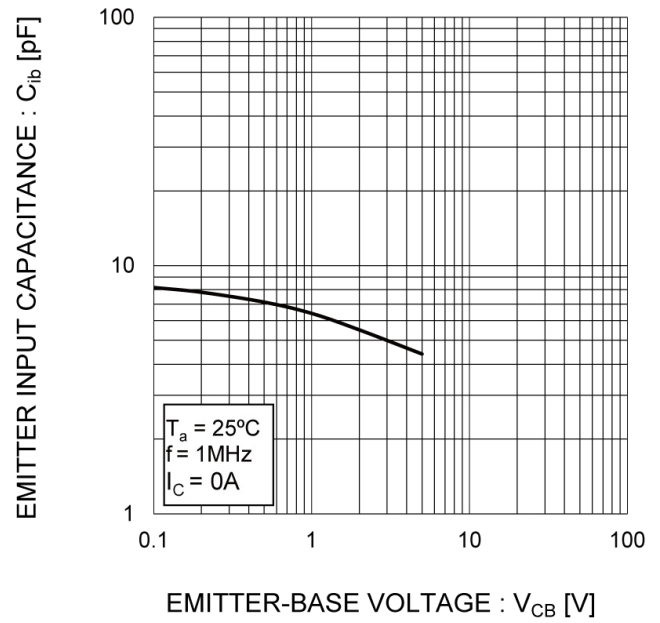
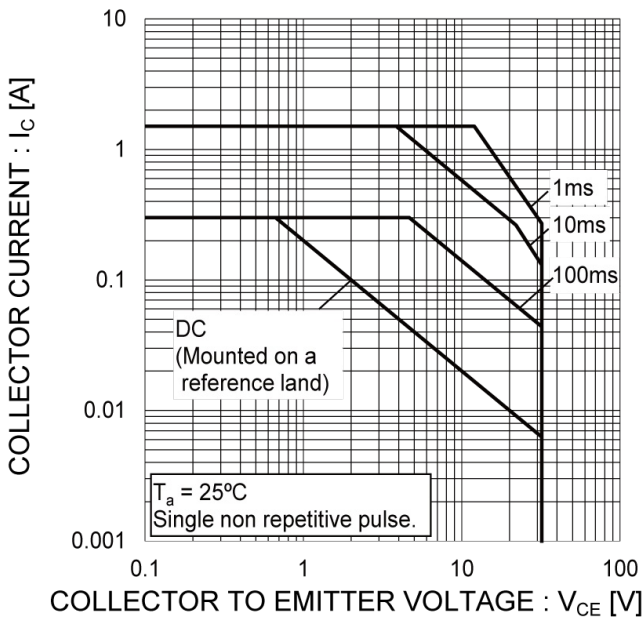
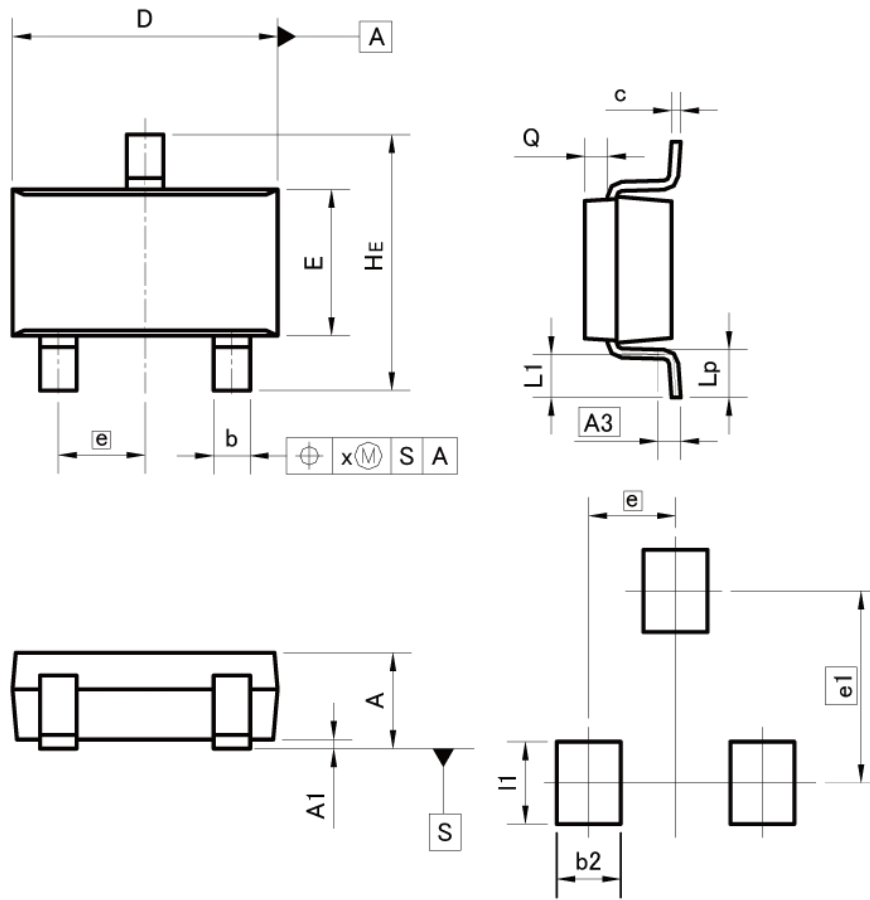


Fig.10 Safe operating area



●Dimensions

SOT-346
SC-59
(SMT3)



Pattern of terminal position areas
[Not a pattern of soldering pads]

DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	1.00	1.30	0.039	0.051
A1	0.00	0.10	0.000	0.004
A3	0.25		0.010	
b	0.35	0.50	0.014	0.020
c	0.09	0.25	0.004	0.010
D	2.80	3.00	0.110	0.118
E	1.50	1.80	0.059	0.071
e	0.95		0.037	
HE	2.60	3.00	0.102	0.118
L1	0.30	0.60	0.012	0.024
Lp	0.40	0.70	0.016	0.028
Q	0.20	0.30	0.008	0.012
x	-	0.10	-	0.004
y	-	0.10	-	0.004

DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
b2	-	0.60	-	0.024
e1	2.10		0.083	
l1	-	0.90	-	0.035

Dimension in mm/inches

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JAPAN	USA	EU	CHINA
CLASS III	CLASS III	CLASS II b	CLASS III
CLASS IV		CLASS III	

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 - Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - Sealing or coating our Products with resin or other coating materials
 - Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - Use of the Products in places subject to dew condensation
- The Products are not subject to radiation-proof design.
- Please verify and confirm characteristics of the final or mounted products in using the Products.
- In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- Confirm that operation temperature is within the specified range described in the product specification.
- ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of Ionizer, friction prevention and temperature / humidity control).

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 - [b] the temperature or humidity exceeds those recommended by ROHM
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 - [d] the Products are exposed to high Electrostatic
2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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2SD1383K - Web Page

[Distribution Inventory](#)

Part Number	2SD1383K
Package	SMT3HP
Unit Quantity	3000
Minimum Package Quantity	3000
Packing Type	Taping
Constitution Materials List	inquiry
RoHS	Yes

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